Preconfigured DSP System for Hearing Aids

Description

The Paragon GB3221 hybrid is a programmable DSP system based on a multi-channel compression circuit. This hybrid is designed for low impedance receivers. It can be used as a platform for a wide range of hearing aid applications. It also offers a separate supply line to the A/D and H-Bridge circuits. The reflowable thinSTAX® packaging enables easy integration into BTE applications. This versatile DSP hybrid is capable of multiple configurations and has a wide range of functions.

The Paragon GB3221 hybrid contains the GC5057 controller featuring Power On Reset (POR) behavior.

The Paragon GB3221 hybrid code programmed into the GC5051 and the GC5057 controller chip is "7".

Features

- High Power Applications
- Highly Configurable, Versatile DSP Platform
- High Fidelity, Multi-channel AGC Signal Processing
- 93 dB Input Dynamic Range with HRX™ Headroom Extension
- Fully Programmable via Serial Data Interface
- High Performance Data Converters Dual, Over–sampled A/Ds; Over-sampled D/A with Efficient Switched-mode Output Power Amp
- High-fidelity Audio Quality
- Drives Zero-bias 2-terminal Receivers
- Multiple Communication Rates up to 85.3 kb/s
- Multi-memory
- Internal/External Volume Control
- Volume Control Taper determined by External VC
- Two Memory Select Pads
- Tri-state Memory Select Operation
- Audible Memory Change Indicator
- Also Available as E1 RoHS Compliant Hybrid

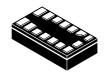
thinSTAX Packaging

• Hybrid Typical Dimensions: 0.227 x 0.125 x 0.060 in (5.76 x 3.18 x 1.52 mm)



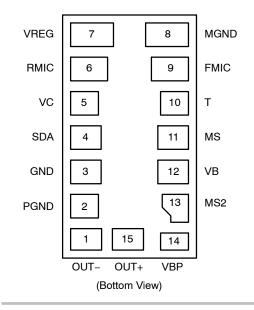
ON Semiconductor®

http://onsemi.com



15 PAD PARAGON CASE TBD

PAD CONNECTION



MARKING DIAGRAM

GB3221-E1 XXXXXX

GB3221 = Specific Device Code = RoHS Compliant Hybrid E1 XXXXXX = Work Order Number

ORDERING INFORMATION

Device	Shipping [†]
GB3221-E1	25 Units / Bubble Pack

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

1

BLOCK DIAGRAM

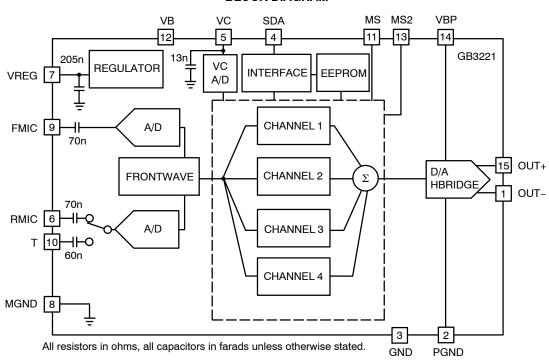


Figure 1. Paragon GB3221 Block Diagram

Table 1. ABSOLUTE MAXIMUM RATINGS

Parameter	Value	Units
Operating Temperature Range	-10 to +40	°C
Storage Temperature Range	-20 to +70	°C
Absolute Maximum Power Dissipation	25	mW
Maximum Operating Supply Voltage	1.5	VDC
Absolute Maximum Supply Voltage	2	VDC

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

WARNING: Electrostatic Sensitive Device - Do not open packages or handle except at a static-free workstation.

WARNING: Moisture Sensitive Device – Non-RoHS Compliant – Level 3 MSL; RoHS Compliant – Level 4 MSL. Do not open packages except under controlled conditions.

Table 2. ELECTRICAL CHARACTERISTICS (Conditions: $V_B = 1.3 \text{ V}$; Temperature = 25°C)

Parameter	Symbol	Conditions	Min	Тур	Max	Units
Hybrid Current	I _{AMP}	See current consumption section	-	700	-	μΑ
Minimum Operating Supply Voltage	V_{BOFF}	Ramp down	0.94	1.0	1.05	V
Supply Voltage Turn On Threshold	V _{BON}	Ramp up	1.06	1.10	1.16	V
Supply Voltage Hysteresis	-	-	90	100	110	mV
Supply Voltage during Communication	V _{BC}	During Communication	1.19	1.35	1.5	٧
Hybrid Current during Communication	l _P	Programming (<5 ms)	-	3.7	-	mA
EEPROM Burn Cycles	-	(Note 2)	100 k	=	-	cycles
Low Frequency System Bandwidth	-	-	100	140	225	Hz
High Frequency System Bandwidth	-	-	15.2	16	16.8	kHz
Total Maximum System Gain	A _V	V _{IN} = -95 dBV at 3 kHz; squelch disabled (Note 1)	81	83	85	dB
Converter Gain	A _{CONV}	A/D + D/A gain	27	29	31	dB
Total Harmonic Distortion	THD	$V_{IN} = -40 \text{ dBV}$	-	0.05	1	%
THD at Maximum Input	THD _M	$V_{IN} = -15$ dBV, HRX – ON	-	1.5	3	%
Clock Frequency	f_{clk}	-	1.945	2.048	2.151	MHz
REGULATOR						
Regulator Voltage	V_{REG}	-	0.90	0.95	1.00	V
Regulator Supply Rejection	PSRR _{REG}	-	-	50	-	dB
INPUT						
Input Referred Noise	IRN	Bandwidth 100 Hz – 8 kHz	-	-108	-106	dBV
Input Impedance	Z _{IN}	-	11.2	16	22	kΩ
Anti-alias Filter Rejection (input referred)	-	$f = f_{\text{clk}} - 8 \text{ kHz},$ $V_{\text{IN}} = -40 \text{ dBV}$	-	80	-	dB
Maximum Input Level	-	-	-	-15	-	dBV
Input Dynamic Range	-	HRX – ON, Bandwidth 100 Hz – 8 kHz	-	93	-	dB
Audio Sample Rate	-	-	30.4	32	33.6	kHz
ОUТРUТ						
Maximum RMS Output Voltage	_	0 dBFS $f = 1$ kHz	-3	-1	1	dBV
D/A Dynamic Range	-	Bandwidth 100 Hz - 8 kHz	80	-	-	dB
Output Impedance	Z _{OUT}	(Note 2)	-	-	20	Ω
VOLUME CONTROL						
Volume Control Resistance	R _{VC}	-	160	200	240	kΩ
Volume Control Range	ΔΑ	-	47.5	48	48.5	dB
MS INPUT						
Low State	Lo	-	0	-	V _{REG} /3	V
Open State	Z	-	V _{REG} /3	-	2V _{REG} /3	V
High State	Hi	-	2V _{REG} /3	-	V _B	V

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

1. Total System Gain consists of: Wideband System Gain + High and Low Independent Channel Gains + Converter Gain.

Total System Gain is calibrated during Cal/Config process.

2. Sample tested.

Table 2. ELECTRICAL CHARACTERISTICS (Conditions: V_B = 1.3 V; Temperature = 25°C)

Parameter	Symbol	Conditions	Min	Тур	Max	Units
MS2 INPUT			•	•	•	•
Pull Down Resistance	-	-	-	1	-	$M\Omega$
Logic 1 Voltage	-	-	V_{REG}	-	V _B	V
Rising Edge Threshold	-	-	0.5	0.69	0.9	V
Falling Edge Threshold	-	-	0.25	0.45	0.5	V
Hysteresis	-	-	0.1	0.24	0.4	V
SDA INPUT						
Logic 0 Voltage	-	(Note 2)	0	=	0.3	V
Logic 1 Voltage	-	(Note 2)	1	-	1.3	V
SDA OUTPUT						
Standby Pull Up Current	-	-	1.4	2	2.6	μΑ
Sync Pull Up Current	-	=	450	500	550	μΑ
Logic 0 Current (Pull Down)	-	=	225	250	275	μΑ
Logic 1 Current (Pull Up)	-	=	225	250	275	μΑ
Synchronization Time (Synchronization Pulse Width)	T _{SYNC}	Baud = 0	237	250	263	μs
		Baud = 1	118	125	132	
		Baud = 2	59	62.5	66	
		Baud = 3	29.76	31.25	32.81	
		Baud = 4	14.88	15.63	16.41	
		Baud = 5	7.44	7.81	8.20	
		Baud = 6	3.72	3.91	4.10	
		Baud = 7	1.86	1.95	2.05	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

Support Software

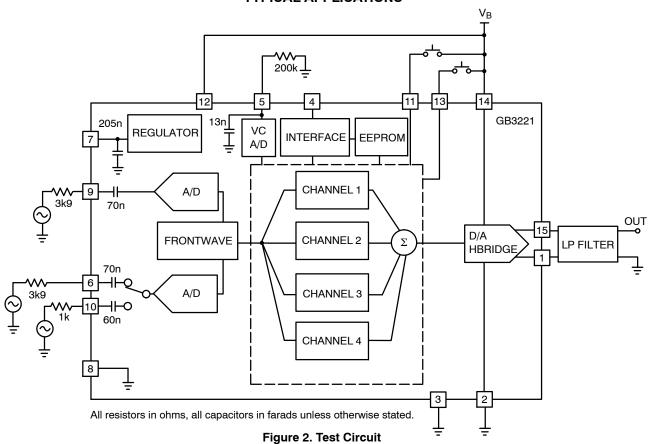
Paragon GA3221 is fully supported by ON Semiconductor's software tools available at ARKonline® website http://ark.onsemi.com/.

^{1.} Total System Gain consists of: Wideband System Gain + High and Low Independent Channel Gains + Converter Gain.

Total System Gain is calibrated during Cal/Config process.

^{2.} Sample tested.

TYPICAL APPLICATIONS



TYPICAL APPLICATIONS (continued)

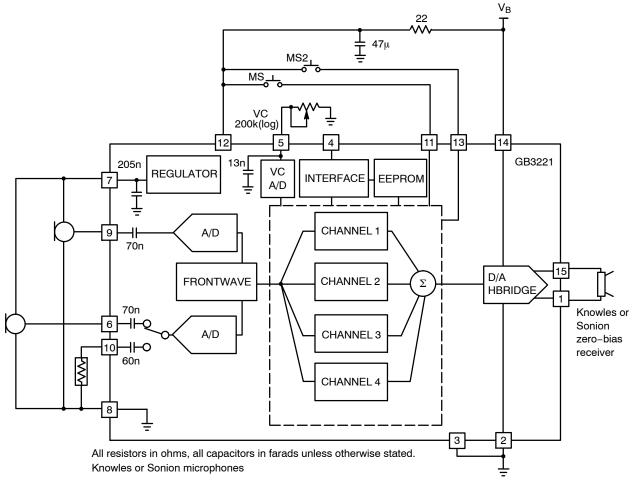


Figure 3. Sample Application Circuit

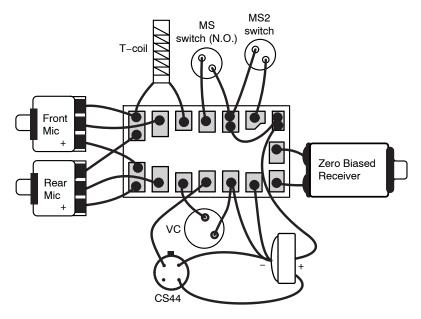
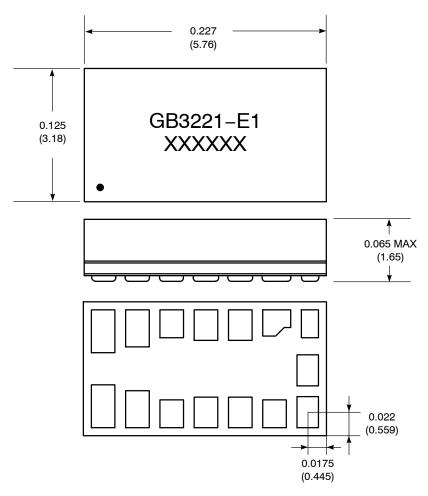


Figure 4. Assembly Diagram

Table 3. PAD POSITION AND DIMENSIONS

	Pad Position		Pad Dim	Pad Dimensions		
Pad No.	Х	Υ	Xdim (mil)	Ydim (mil)		
1	0	0	20	29		
2	-31	-1.5	22	26		
3	-63	-0.25	22	28.5		
4	-95	-0.25	22	28.5		
5	-127	-1.5	22	26		
6	-159	2.75	22	34.5		
7	-191	5.5	22	40		
8	-191	75.5	22	40		
9	-159	78.25	22	34.5		
10	-127	82.5	22	26		
11	-95	81.25	22	28.5		
12	-63	81.25	22	28.5		
13	-30	85.5	26	24.5		
14	2	82.5	16	26		
15	0	39	20	29		
Pad No.	Х	Υ	Xdim (mm)	Ydim (mm)		
1	0	0	0.508	0.737		
2	-0.787	-0.038	0.559	0.660		
3	-1.600	-0.006	0.559	0.724		
4	-2.413	-0.006	0.559	0.724		
5	-3.226	-0.038	0.559	0.660		
6	-4.039	0.070	0.559	0.876		
7	-4.851	0.140	0.559	1.016		
8	-4.851	1.918	0.559	1.016		
9	-4.039	1.988	0.559	0.876		
10	-3.226	2.0965	0.559	0.660		
11	-2.413	2.0638	0.559	0.724		
12	-1.600	2.0638	0.559	0.724		
13	0.762	2.172	0.660	0.622		
14	0.051	2.096	0.406	0.660		
15	0	0.991	0.508	0.737		

PACKAGE DIMENSIONS



Dimension units are in inches.

Dimensions in parentheses are in millimeters, converted from inches and include minor rounding errors.

1.000 inches = 25.4 mm

Dimension tolerances: ±0.003 (±0.08) unless otherwise stated.

= location of Pin 1

Work order number: XXXXXX

RoHS compliant hybrid, MSL#4, 240°C peak reflow, SAC305.

This Hybrid is designed for either point-to-point manual soldering or for reflow according to ON Semiconductor's reflow process.

ARKonline, FRONTWAVE, and thinSTAX are registered trademarks of Semiconductor Components Industries, LLC. HRX is a trademark of Semiconductor Components Industries, LLC.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor P.O. Box 5163, Denver, Colorado 80217 USA Phone: 303–675–2175 or 800–344–3860 Toll Free USA/Canada

Fax: 303-675-2175 or 800-344-3860 foil Free USA/Canada

Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada

Email: orderlit@onsemi.com

N. American Technical Support: 800-282-9855 Toll Free USA/Canada

Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910 Japan Customer Focus Center

Phone: 81-3-5817-1050

ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative